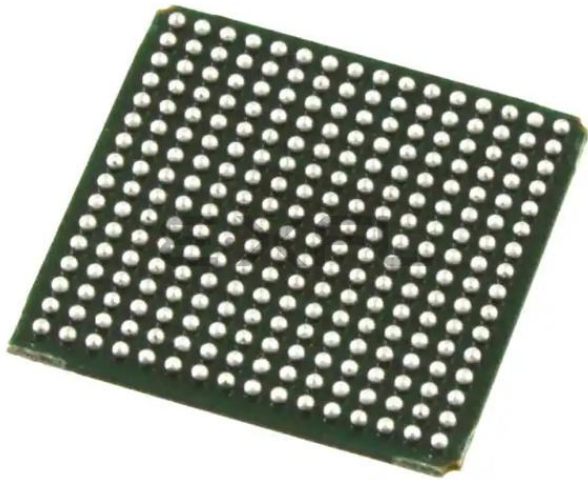




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	1936
Total RAM Bits	94208
Number of I/O	160
Number of Gates	139000
Voltage - Supply	2.3V ~ 3.6V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfx125eb-04f256i

ispXPGA Family Overview

The ispXPGA family of devices provides the ideal vehicle for the creation of high-performance logic designs that are both non-volatile and infinitely re-programmable. Other FPGA solutions force a compromise, being either re-programmable or non-volatile. This family couples this capability with a mainstream architecture containing the features required for today's system-level design.

The ispXPGA family is available in two options. The standard device supports sysHSI capability for ultra fast serial communications while the lower-cost "E-Series" supports the same high-performance FPGA fabric without the sysHSI Block.

Electrically Erasable CMOS (E²CMOS) memory cells provide the ispXPGA family with non-volatile capability. These allow logic to be functional microseconds after power is applied, allowing easy interfacing in many applications. This capability also means that expensive external configuration memories are not required and that designs can be secured from unauthorized read back. Internal SRAM cells allow the device to be infinitely reconfigured if desired. Both the SRAM and E²CMOS cells can be programmed and verified through the IEEE 1532 industry standard. Additionally, the SRAM cells can be configured and read-back through the sysCONFIG™ peripheral port.

The family spans the density and I/O range required for the majority of today's logic designs, 139K to 1.25M functional gates and 160 to 496 I/O. The devices are available for operation from 1.8V, 2.5V, and 3.3V power supplies, providing easy integration into the overall system.

System-level design needs are met through the incorporation of sysMEM dual-port memory blocks, sysIO advanced I/O support, and sysCLOCK Phase Locked Loops (PLLs). High-speed serial communications are supported through multiple sysHSI blocks, which provide clock data recovery (CDR) and serialization/de-serialization (SERDES).

The ispLEVER™ design tool from Lattice allows easy implementation of designs using the ispXPGA product. Synthesis library support is available for major logic synthesis tools. The ispLEVER tool takes the output from these common synthesis packages and place and routes the design in the ispXPGA product. The tool supports floor planning and the management of other constraints within the device. The tool also provides outputs to common timing analysis tools for timing analysis.

To increase designer productivity, Lattice provides a variety of pre-designed modules referred to as IP cores for the ispXPGA product. These IP cores allow designers to concentrate on the unique portions of their design while using pre-designed blocks to implement standard functions such as bus interfaces, standard communication interfaces, and memory controllers.

Through the use of advanced technology and innovative architecture the ispXPGA FPGA devices provide designers with excellent speed performance. Although design dependent, many typical designs can run at over 150MHz. Certain designs can run at over 300MHz. Table 2 details the performance of several building blocks commonly used by logic designers.

Table 2. ispXPGA Speed Performance for Typical Building Blocks

Function	Performance
8:1 Asynch MUX	150 MHz
1:32 Asynch Demultiplexer	125 MHz
8 x 8 2-LL Pipelined Multiplier	225 MHz
32-bit Up/Down Counter	290 MHz
32-bit Shift Register	360 MHz

sysCLOCK PLL Description

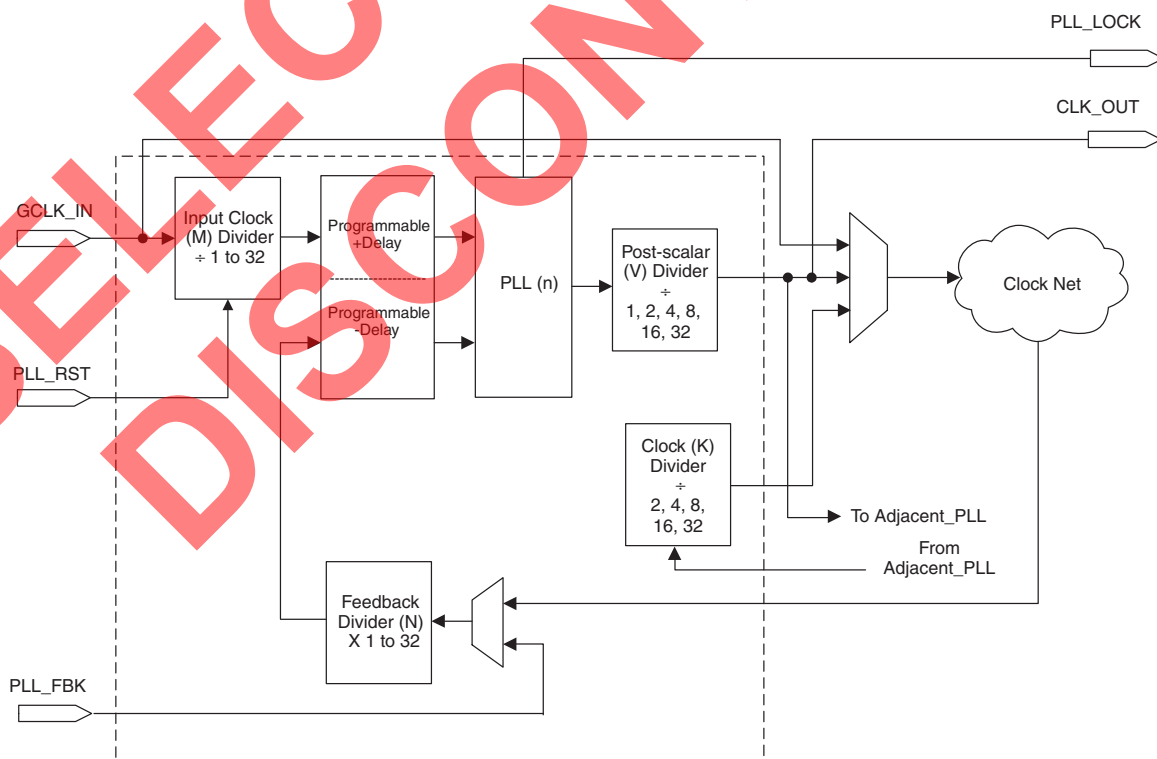
The sysCLOCK PLL circuitry consists of Phase-Lock Loops (PLLs) and the various dividers, reset, and feedback signals associated with the PLLs. This feature gives the user the ability to synthesize clock frequencies and generate multiple clock signals for routing within the device. Furthermore, it can generate clock signals that are aligned either at the board level or the device level.

The ispXPGA devices provide up to eight PLLs. Each PLL receives its input clock from its associated global clock pin, and its output is routed to the associated global clock net. For example, PLL0 receives its clock input from the GCLK0 global clock pin and provides output to the CLK0 global clock net. The PLL also has the ability to output a secondary clock that is a division of the primary clock output. When using the secondary clock, the secondary clock will be routed to the neighboring global clock net. For example, PLL0 will drive its primary clock output on the CLK0 global clock net and its secondary clock output will drive the CLK1 global clock net. Additionally, each PLL has a set of PLL_RST, PLL_FBK, and PLL_LOCK signals. The PLL_RST signal can be generated through routing or a dedicated dual-function I/O pin. The PLL_FBK signal can be generated through a dedicated dual-function I/O pin or internally from the Global Clock net associated with the PLL. The PLL_LOCK signal feeds routing directly from the sysCLOCK PLL circuit. Figure 17 illustrates how the PLL_RST and PLL_FBK signals are generated.

Each PLL has four dividers associated with it, M, N, V, and K. The M divider is used to divide the clock signal, while the N divider is used to multiply the clock signal. The V divider allows the VCO frequency to operate at higher frequencies than the clock output, thereby increasing the frequency range. The K divider is only used when a secondary clock output is needed. This divider divides the primary clock output and feeds to the adjacent global clock net. Different combinations of these dividers allow the user to synthesize clock frequencies. Figure 16 shows the ispXPGA PLL block diagram.

The PLL also has a delay feature that allows the output clock to be advanced or delayed to improve set-up and clock-to-out times for better performance. This operates by inserting delay on the input or feedback lines of the PLL. For more information on the PLL, please refer to TN1003, [sysCLOCK PLL Usage and Design Guidelines](#).

Figure 16. ispXPGA PLL Block Diagram



Absolute Maximum Ratings^{1, 2, 3}

	1.8V	2.5V/3.3V
Supply Voltage (V_{CC})	-0.5 to 2.5V	-0.5 to 5.5V
PLL Supply Voltage (V_{CCP})	-0.5 to 2.5V	-0.5 to 5.5V
Output Supply Voltage (V_{CCO})	-0.5 to 4.5V	-0.5 to 4.5V
IEEE 1149.1 TAP Supply Voltage (V_{CCJ})	-0.5 to 4.5V	-0.5 to 4.5V
Input Voltage Applied ^{4, 5}	-0.5 to 5.5V	-0.5 to 5.5V
Storage Temperature	-65 to 150°C	-65 to 150°C
Junction Temperature (T_J) with Power Applied	-55 to 150°C	-55 to 150°C

1. Stress above those listed under the “Absolute Maximum Ratings” may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied (while programming, following the programming specifications).
2. Compliance with the Lattice [Thermal Management](#) document is required.
3. All voltages referenced to GND.
4. Overshoot and undershoot of -2V to (V_{IH} (MAX) + 2) volts not to exceed 6V is permitted for a duration of <20ns.
5. A maximum of 64 I/Os per device with $V_{IN} > 3.6V$ is allowed.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
V_{CC}	Supply Voltage for 1.8V device ¹	1.65	1.95	V
	Supply Voltage for 2.5V device	2.3	2.7	V
	Supply Voltage for 3.3V device	3.0	3.6	V
V_{CCP}	Supply Voltage for PLL and sysHSI blocks, 1.8V devices ¹	1.65	1.95	V
	Supply Voltage for PLL and sysHSI blocks, 2.5V devices	2.3	2.7	V
	Supply Voltage for PLL and sysHSI blocks, 3.3V devices	3.0	3.6	V
V_{CCJ}	Supply Voltage for IEEE 1149.1 Test Access Port for LVCMOS 1.8V	1.65	1.95	V
	Supply Voltage for IEEE 1149.1 Test Access Port for LVCMOS 2.5V	2.3	2.7	V
	Supply Voltage for IEEE 1149.1 Test Access Port for LVCMOS 3.3V	3.0	3.6	V
T_J (COM)	Junction Temperature Commercial Operation	0	85	C
T_J (IND)	Junction Temperature Industrial Operation	-40	105	C

¹ sysHSI specification is valid for V_{CC} and $V_{CCP} = 1.7V$ to $1.9V$.

E²CMOS Erase Reprogram Specifications

Parameter	Min	Max	Units
Erase/Reprogram Cycle ¹	1,000	—	Cycles

¹ Valid over commercial temperature range.

Hot Socketing Characteristics^{1, 2, 3, 4}

Symbol	Parameter	Condition	Min	Typ	Max	Units
I_{DK}	Input or Tristated I/O Leakage Current	$0 \leq V_{IN} \leq 3.0V$	—	+/-50	+/-800	μA

1. Insensitive to sequence of V_{CC} and V_{CCO} when $V_{CCO} \leq 1.0V$. For $V_{CCO} > 1.0V$, V_{CC} min must be present. However, assumes monotonic rise/fall rates for V_{CC} and V_{CCO} , provided $(V_{IN} - V_{CCO}) \leq 3.6V$.
2. LVTTTL, LVCMOS only.
3. $0 < V_{CC} \leq V_{CC} (MAX)$, $0 < V_{CCO} \leq V_{CCO} (MAX)$.
4. I_{DK} is additive to I_{PU} , I_{PD} or I_{BH} . Device defaults to pull-up until non-volatile cells are active.

sysIO DC Electrical Characteristics

Over Recommended Operating Conditions

Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL} (mA)	I_{OH} (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	5.5	0.4	$V_{CCO} - 0.4$	20, 16, 12, 8, 5.33, 4	-20, -16, -12, -8, -5.33, -4
					0.2	$V_{CCO} - 0.2$	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	$V_{CCO} - 0.4$	16, 12, 8, 5.33, 4	-16, -12, -8, -5.33, -4
					0.2	$V_{CCO} - 0.2$	0.1	-0.1
LVCMOS 1.8 ¹	-0.3	0.68 ³	1.07 ³	3.6	0.4	$V_{CCO} - 0.4$	12, 8 ¹ , 5.33, 4	-12, -8 ¹ , -5.33, -4
		0.35 V_{CC}	0.65 V_{CC}		0.2	$V_{CCO} - 0.2$	0.1	-0.1
LVTTTL	-0.3	0.8	2.0	5.5	0.4	$V_{CCO} - 0.4$	4	-4
					0.2	$V_{CCO} - 0.2$	0.1	-0.1
PCI 3.3	-0.3	1.08 ³	1.5 ³	5.5	0.1 V_{CCO}	0.9 V_{CCO}	1.5	-0.5
		0.3 V_{CCO}	0.5 V_{CCO}					
AGP-1X	-0.3	1.08 ³	1.5 ³	3.6	0.1 V_{CCO}	0.9 V_{CCO}	1.5	-0.5
		0.3 V_{CCO}	0.5 V_{CCO}					
SSTL 3 Class I	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.7	$V_{CCO} - 1.1$	8	-8
SSTL 3 Class II	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.5	$V_{CCO} - 0.9$	16	-16
SSTL 2 Class I	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.54	$V_{CCO} - 0.62$	7.6	-7.6
SSTL 2 Class II	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.35	$V_{CCO} - 0.43$	15.2	-15.2
CTT 3.3	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	$V_{REF} - 0.4$	$V_{REF} + 0.4$	8	-8
CTT 2.5	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	$V_{REF} - 0.4$	$V_{REF} + 0.4$	8	-8
HSTL Class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCO} - 0.4$	8	-8
HSTL Class III	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCO} - 0.4$	24	-8
GTL+	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.6	N/A	36	N/A

1. Design tool default setting.

2. The average DC current drawn by I/Os between adjacent bank GND connections, or between the last GND in an I/O bank and the end of the I/O bank, as shown in the logic signals connection table, shall not exceed $n \cdot 8\text{mA}$. Where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

3. Applicable for ispXPGA B devices.

ispXPGA 125B/C & ispXPGA 125EB/EC EBR Timing Parameters

Parameter	Description	-5 ¹		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Synchronous Write								
t _{EBSWAD_S}	Address Setup Delay	0.59	—	0.61	—	0.70	—	ns
t _{EBSWAD_H}	Address Hold Delay	-0.40	—	-0.39	—	-0.33	—	ns
t _{EBSWCPW}	Clock Pulse Width	3.16	—	3.40	—	3.91	—	ns
t _{EBSWWE_S}	Write Enable Setup Time	-0.12	—	-0.12	—	-0.10	—	ns
t _{EBSWWE_H}	Write Enable Hold Time	0.16	—	0.16	—	0.18	—	ns
t _{EBSWD_S}	Data Setup Time	0.27	—	0.28	—	0.32	—	ns
t _{EBSWD_H}	Data Hold Time	-0.27	—	-0.26	—	-0.22	—	ns
Synchronous Read								
t _{EBSR_CO}	Clock to Data Delay	—	2.04	—	2.19	—	2.52	ns
t _{EBSRAD_S}	Address Setup Delay	0.10	—	0.10	—	0.12	—	ns
t _{EBSRAD_H}	Address Hold Delay	-0.07	—	-0.07	—	-0.06	—	ns
t _{EBSRCPW}	Clock Pulse Width	3.16	—	3.40	—	3.91	—	ns
t _{EBSRCE_S}	Clock Enable Setup Time	-1.76	—	-1.71	—	-1.45	—	ns
t _{EBSRCE_H}	Clock Enable Hold Time	1.64	—	1.69	—	1.94	—	ns
t _{EBSRWE_S}	Write Enable Setup Time	-0.18	—	-0.17	—	-0.14	—	ns
t _{EBSRWE_H}	Write Enable Hold Time	0.12	—	0.12	—	0.14	—	ns
t _{EBSRWEEN}	Write Enable to Data Enable Time	—	1.02	—	1.05	—	1.21	ns
t _{EBSRWEDIS}	Write Enable to Data Disable Time	—	0.99	—	1.02	—	1.17	ns
t _{EBSREN}	Output Enable to Data Enable Time	—	1.02	—	1.05	—	1.21	ns
t _{EBSRDIS}	Output Enable to Data Disable Time	—	0.83	—	0.86	—	0.99	ns
Asynchronous Read								
t _{EBARADO}	Address to New Valid Data Delay	—	2.39	—	2.46	—	2.83	ns
t _{EBARAD_H}	Address to Previous Valid Data Delay	—	2.10	—	2.17	—	2.50	ns
t _{EBARWEEN}	Write Enable to Data Enable Time	—	1.01	—	1.04	—	1.20	ns
t _{EBARWEDIS}	Write Enable to Data Disable Time	—	0.98	—	1.01	—	1.16	ns
t _{EBAREN}	Output Enable to Data Enable Time	—	1.02	—	1.05	—	1.21	ns
t _{EBARDIS}	Output Enable to Data Disable Time	—	0.83	—	0.86	—	0.99	ns

1. Only available for ispXPGA 125B and ispXPGA 125EB (2.5V/3.3V) devices.

Timing v.0.3

ispXPGA 125B/C & ispXPGA 125EB/EC Timing Adders

Parameter	Description	Base Parameter	-5 ¹		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
Optional Adders									
t _{IOINDLY}	Input Delay	—	—	4.28	—	4.6	—	5.29	ns
t _{IOI} Input Adjusters									
LVTTL_in	Using 3.3V TTL	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_18_in	Using 1.8V CMOS	t _{IOIN}	—	0.0	—	0.0	—	0.0	ns
LVC MOS_25_in	Using 2.5V CMOS	t _{IOIN}	—	0.3	—	0.3	—	0.3	ns
LVC MOS_33_in	Using 3.3V CMOS	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
AGP_1X_in	Using AGP 1x	t _{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT25_in	Using CTT 2.5V	t _{IOIN}	—	1.0	—	1.0	—	1.0	ns
CTT33_in	Using CTT 3.3V	t _{IOIN}	—	1.0	—	1.0	—	1.0	ns
GTL+_in	Using GTL+	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_I_in	Using HSTL 2.5V, Class I	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
HSTL_III_in	Using HSTL 2.5V, Class III	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
LVDS_in	Using Low Voltage Differential Signaling (LVDS)	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
BLVDS_in	Using Bus Low Voltage Differential Signaling (BLVDS)	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
LVPECL_in	Using Low Voltage PECL	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
PCI_in	Using PCI	t _{IOIN}	—	1.0	—	1.0	—	1.0	ns
SSTL2_I_in	Using SSTL 2.5V, Class I	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL2_II_in	Using SSTL 2.5V, Class II	t _{IOIN}	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_in	Using SSTL 3.3V, Class I	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
SSTL3_II_in	Using SSTL 3.3V, Class II	t _{IOIN}	—	0.8	—	0.8	—	0.8	ns
t _{IOO} Output Adjusters									
Slow Slew	Using Slow Slew (LVTTL and LVC MOS Outputs only)	t _{IOBUF} t _{IOEN}	—	0.7	—	0.7	—	0.7	ns
LVTTL_out	Using 3.3V TTL Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	1.0	—	1.0	—	1.0	ns
LVC MOS_18_4mA_out	Using 1.8V CMOS Standard, 4mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.8	—	0.8	—	0.8	ns
LVC MOS_18_5.33mA_out	Using 1.8V CMOS Standard, 5.33mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.6	—	0.6	—	0.6	ns
LVC MOS_18_8mA_out	Using 1.8V CMOS Standard, 8mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.0	—	0.0	—	0.0	ns
LVC MOS_18_12mA_out	Using 1.8V CMOS Standard, 12mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.2	—	0.2	—	0.2	ns
LVC MOS_25_4mA_out	Using 2.5V CMOS Standard, 4mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.7	—	0.7	—	0.7	ns
LVC MOS_25_5.33mA_out	Using 2.5V CMOS Standard, 5.33 mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_25_8mA_out	Using 2.5V CMOS Standard, 8mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_25_12mA_out	Using 2.5V CMOS Standard, 12mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns
LVC MOS_25_16mA_out	Using 2.5V CMOS Standard, 16mA Drive	t _{IOBUF} , t _{IOEN} , t _{IODIS}	—	0.5	—	0.5	—	0.5	ns

ispXPGA 500B/C & ispXPGA 500EB/EC External Switching Characteristics**Over Recommended Operating Conditions**

Parameter	Description	Conditions	-5 ¹		-4		-3		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{CO}	Global Clock Input to Output	PIO Output Register	—	6.4	—	6.9	—	7.9	ns
t_S	Global Clock Input Setup	PIO Input Register without input delay	-2.9	—	-2.7	—	-2.3	—	ns
t_H	Global Clock Input Hold	PIO Input Register without input delay	3.6	—	3.9	—	4.5	—	ns
t_{SINDLY}	Global Clock Input Setup	PIO Input Register with input delay	3.3	—	3.6	—	4.1	—	ns
t_{HINDLY}	Global Clock Input Hold	PIO Input Register with input delay	0.0	—	0.0	—	0.0	—	ns
t_{COPLL}	Global Clock Input to Output	PIO Output Register using PLL without delay	—	3.2	—	3.4	—	3.9	ns
t_{SPLL}	Global Clock Input Setup	PIO Input Register without input delay using PLL without delay	0.1	—	0.2	—	0.3	—	ns
t_{HPLL}	Global Clock Input Hold	PIO Input Register without input delay using PLL without delay	0.8	—	0.9	—	1.0	—	ns
$t_{SINDLYPLL}$	Global Clock Input Setup	PIO Input Register with input delay using PLL without delay	6.7	—	7.2	—	8.3	—	ns
$t_{HINDLYPLL}$	Global Clock Input Hold	PIO Input Register with input delay using PLL without delay	-4.3	—	-4.0	—	-3.4	—	ns

1. Only available for ispXPGA 500B and ispXPGA 500EB (2.5V/3.3V) devices.

Timing v.0.3

ispXPGA 1200B/C & ispXPGA 1200EB/EC EBR Timing Parameters

Parameter	Description	-5 ¹		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Synchronous Write								
t _{EBSWAD_S}	Address Setup Delay	0.59	—	0.61	—	0.70	—	ns
t _{EBSWAD_H}	Address Hold Delay	-0.40	—	-0.39	—	-0.33	—	ns
t _{EBSWCPW}	Clock Pulse Width	3.16	—	3.40	—	3.91	—	ns
t _{EBSWWE_S}	Write Enable Setup Time	-0.12	—	-0.12	—	-0.10	—	ns
t _{EBSWWE_H}	Write Enable Hold Time	0.16	—	0.16	—	0.18	—	ns
t _{EBSWD_S}	Data Setup Time	0.27	—	0.28	—	0.32	—	ns
t _{EBSWD_H}	Data Hold Time	-0.27	—	-0.26	—	-0.22	—	ns
Synchronous Read								
t _{EBSR_CO}	Clock to Data Delay	—	2.04	—	2.19	—	2.52	ns
t _{EBSRAD_S}	Address Setup Delay	0.10	—	0.10	—	0.12	—	ns
t _{EBSRAD_H}	Address Hold Delay	-0.07	—	-0.07	—	-0.06	—	ns
t _{EBSRCPW}	Clock Pulse Width	3.16	—	3.40	—	3.91	—	ns
t _{EBSRCE_S}	Clock Enable Setup Time	-1.76	—	-1.71	—	-1.45	—	ns
t _{EBSRCE_H}	Clock Enable Hold Time	1.64	—	1.69	—	1.94	—	ns
t _{EBSRWE_S}	Write Enable Setup Time	-0.18	—	-0.17	—	-0.14	—	ns
t _{EBSRWE_H}	Write Enable Hold Time	0.12	—	0.12	—	0.14	—	ns
t _{EBSRWEEN}	Write Enable to Data Enable Time	—	1.02	—	1.05	—	1.21	ns
t _{EBSRWEDIS}	Write Enable to Data Disable Time	—	0.99	—	1.02	—	1.17	ns
t _{EBSREN}	Output Enable to Data Enable Time	—	1.02	—	1.05	—	1.21	ns
t _{EBSRDIS}	Output Enable to Data Disable Time	—	0.83	—	0.86	—	0.99	ns
Asynchronous Read								
t _{EBARADO}	Address to New Valid Data Delay	—	2.39	—	2.46	—	2.83	ns
t _{EBARAD_H}	Address to Previous Valid Data Delay	—	2.10	—	2.17	—	2.50	ns
t _{EBARWEEN}	Write Enable to Data Enable Time	—	1.01	—	1.04	—	1.20	ns
t _{EBARWEDIS}	Write Enable to Data Disable Time	—	0.98	—	1.01	—	1.16	ns
t _{EBAREN}	Output Enable to Data Enable Time	—	1.02	—	1.05	—	1.21	ns
t _{EBARDIS}	Output Enable to Data Disable Time	—	0.83	—	0.86	—	0.99	ns

1. Only available for ispXPGA 1200B and ispXPGA 1200EB (2.5V/3.3V) devices.

Timing v.2.1

Signal Descriptions¹

Signal Name	Signal Type	Description
General Purpose		
BKy_IOx ^{1,2}	Input/Output	General purpose I/O number x in I/O Bank y
GCLKn/In ⁷	Input	Global clock/input ⁸
GSR	Input	Global Set/Reset
NC	—	No Connect
GND	GND	Ground
V _{CC}	VCC	Core logic power supply
V _{CCJ}	VCC	IEEE 1149.1 TAP power supply
V _{CCOy} ²	VCC	I/O Bank y power supply
V _{REFy} ²	Input	I/O Bank y reference voltage
D _{XN} , D _{XP}	Output	Temperature Sensing Diodes, provide a differential voltage, which corresponds to the temperature of the device.
Test and Program/Configuration		
TMS	Input	Test Mode Select
TCK	Input	Test Clock
TDI	Input	Test Data In
TDO	Output	Test Data Out
TOE	Input	Test Output Enable tri-states all I/O pins when driven low
CFG0	Input	Selects the SRAM memory configuration type (Peripheral or E ² CMOS Refresh)
PROGRAMb	Input	Initiates download from E ² CMOS or the peripheral port to SRAM memory (active low)
DONE	Bi-directional	Indicates when configuration is complete
INITb	Bi-directional	Indicates the device is ready for programming (active low)
READ	Input	Selects the READ operation when in sysCONFIG mode
CCLK	Input	sysCONFIG Configuration Clock
CSb	Input	sysCONFIG Chip Select (active low)
DATA[0:7]	Bi-directional	sysCONFIG Peripheral Port Data I/O
sysCLOCK PLL³		
PLL_FBKz	Input	Optional external feedback
PLL_RSTz	Input	Optional external M divider reset
CLK_OUTz	Internal Signal	Clock output (routable to any I/O)
PLL_LOCKz	Internal Signal	Lock output (routable to any I/O)
GND _{P0}	GND	Left side PLL Ground
GND _{P1}	GND	Right side PLL Ground
V _{CCP0}	VCC	Left side PLL power supply
V _{CCP1}	VCC	Right side PLL power supply
sysHSI Block^{4, 5}		
HSImA_SINP, HSImB_SINP	Input	P-side of differential serial data input
HSImA_SINN, HSImB_SINN	Input	N-side of differential serial data input
HSImA_SOUTP, HSImB_SOUTP	Output	P-side of differential serial data output
HSImA_SOUTN, HSImB_SOUTN	Output	N-side of differential serial data output
HSImA_SYDT, HSImB_SYDT	Internal Signal	Symbol alignment detect
HSImA_RECCLK, HSImB_RECCLK	Internal Signal	Recovered clock

ispXPGA Power Supply and NC Connections¹ (Continued)

Signal	680-Ball fpBGA ³	900-Ball fpBGA ³
V _{CC}	AE35, AE5, AL5, AR15, AR25, AR31, AR35, AR5, AT36, AT4, AU3, AU37, C3, C37, D36, D4, E15, E25, E35, E5, E9, J35, R35, R5	L11, L20, M12, M13, M14, M17, M18, M19, N12, N19, P12, P19, U12, U19, V12, V19, W12, W13, W14, W17, W18, W19, Y11, Y20
V _{CCO0}	E11, E12, E13, E17, E18, E7	K3, L10, M11, N11, N5, P11, R11, R12
V _{CCO1}	E22, E23, E27, E29, E31, E33	AA3, T11, T12, U11, V11, V5, W11, Y10
V _{CCO2}	G35, L35, M35, N35, U35, V35	AA11, AF13, AH10, W15, Y12, Y13, Y14, Y15
V _{CCO3}	AB35, AC35, AG35, AJ35, AL35, AN35	AA20, AF18, AH21, W16, Y16, Y17, Y18, Y19
V _{CCO4}	AR22, AR23, AR27, AR28, AR29, AR33	AA28, T19, T20, U20, V20, V26, W20, Y21
V _{CCO5}	AR11, AR13, AR17, AR18, AR7, AR9	K28, L21, M20, N20, N26, P20, R19, R20
V _{CCO6}	AB5, AC5, AG5, AH5, AJ5, AN5	C21, E18, K20, L16, L17, L18, L19, M16
V _{CCO7}	G5, J5, L5, N5, U5, V5	C10, E13, K11, L12, L13, L14, L15, M15
V _{CCP}	E20, AW22	R5, T26
V _{CCJ}	D3	B3
GND	A1, A2, A20, A38, A39, AE3, AE37, AK3, AK37, AR36, AR4, AT20, AT35, AT5, AU10, AU14, AU20, AU26, AU30, AV1, AV2, AV20, AV38, AV39, AW1, AW2, AW20, AW38, AW39, B1, B2, B20, B38, B39, C10, C14, C20, C26, C30, D20, D35, D5, E36, E4, K3, K37, P37, R3, Y1, Y2, Y3, Y36, Y37, Y38, Y39, Y4	A1, A2, A29, A30, AB28, AB3, AG27, AG4, AH22, AH28, AH3, AH9, AJ1, AJ2, AJ29, AJ30, AK1, AK2, AK29, AK30, B1, B2, B29, B30, C22, C28, C3, C9, D27, D4, J28, J3, N13, N14, N15, N16, N17, N18, P13, P14, P15, P16, P17, P18, R13, R14, R15, R16, R17, R18, T13, T14, T15, T16, T17, T18, U13, U14, U15, U16, U17, U18, V13, V14, V15, V16, V17, V18
GND _P	AR20, A21	R28, T3

ispXPGA Logic Signal Connections: 256-Ball fpBGA

256-fpBGA Ball	LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ²	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ²
C2	BK0_IO2	HSI0A_SOUTP	1P/HSI0	BK0_IO0	HSI0A_SOUTP	0P
-	GND (Bank 0)	-	-	-	-	-
D2	BK0_IO3	HSI0A_SOUTN	1N/HSI0	BK0_IO1	HSI0A_SOUTN	0N
B1	BK0_IO6	HSI0A_SINP	3P/HSI0	BK0_IO4	HSI0A_SINP	2P/HSI0
-	-	-	-	GND (Bank 0)	-	-
C1	BK0_IO7	HSI0A_SINN	3N/HSI0	BK0_IO5	HSI0A_SINN	2N/HSI0
D3	BK0_IO8	-	4P/HSI0	BK0_IO6	-	3P/HSI0
E3	BK0_IO9	VREF0	4N/HSI0	BK0_IO7	VREF0	3N/HSI0
D1	BK0_IO10	HSI0B_SOUTP	5P/HSI0	BK0_IO8	HSI0B_SOUTP	4P/HSI0
-	GND (Bank 0)	-	-	-	-	-
E1	BK0_IO11	HSI0B_SOUTN	5N/HSI0	BK0_IO9	HSI0B_SOUTN	4N/HSI0
E2	BK0_IO12	-	6P/HSI0	BK0_IO10	-	5P/HSI0
F2	BK0_IO13	-	6N/HSI0	BK0_IO11	-	5N/HSI0
F1	BK0_IO14	HSI0B_SINP	7P/HSI0	BK0_IO12	HSI0B_SINP	6P/HSI0
-	-	-	-	GND (Bank 0)	-	-
G1	BK0_IO15	HSI0B_SINN	7N/HSI0	BK0_IO13	HSI0B_SINN	6N/HSI0
F3	BK0_IO18	PLL_FBK0	9P	BK0_IO14	PLL_FBK0	7P/HSI0
-	GND (Bank 0)	-	-	-	-	-
G2	BK0_IO19	PLL_RST1	9N	BK0_IO15	PLL_RST1	7N/HSI0
E4	BK0_IO20	-	10P	BK0_IO16	-	8P/HSI0
F4	BK0_IO21	PLL_FBK1	10N	BK0_IO17	PLL_FBK1	8N/HSI0
H1	BK0_IO22	PLL_RST0	11P	BK0_IO18	PLL_RST0	9P
-	-	-	-	GND (Bank 0)	-	-
J1	BK0_IO23	-	11N	BK0_IO19	-	9N
H2	BK0_IO24	CLK_OUT0	12P	BK0_IO20	CLK_OUT0	10P
G3	BK0_IO25	CLK_OUT1	12N	BK0_IO21	CLK_OUT1	10N
-	GND (Bank 0)	-	-	-	-	-
G4	GCLK0	-	LVDS Pair0P	GCLK0	-	LVDS Pair0P
H4	GCLK1	-	LVDS Pair0N	GCLK1	-	LVDS Pair0N
H3	VCCP0	-	-	VCCP0	-	-
J4	GNDP0	-	-	GNDP0	-	-
J2	GCLK2	-	LVDS Pair1P	GCLK2	-	LVDS Pair1P
J3	GCLK3	-	LVDS Pair1N	GCLK3	-	LVDS Pair1N
-	GND (Bank 1)	-	-	-	-	-
H5	BK1_IO0	CLK_OUT2	13P	BK1_IO0	CLK_OUT2	11P
J5	BK1_IO1	CLK_OUT3	13N	BK1_IO1	CLK_OUT3	11N
K1	BK1_IO2	SS_CLKOUT0P	14P	BK1_IO2	SS_CLKOUT0P	12P
-	-	-	-	GND (Bank 1)	-	-
L1	BK1_IO3	SS_CLKOUT0N	14N	BK1_IO3	SS_CLKOUT0N	12N
K4	BK1_IO4	PLL_FBK2	15P	BK1_IO4	PLL_FBK2	13P
L4	BK1_IO5	PLL_FBK3	15N	BK1_IO5	PLL_FBK3	13N
K3	BK1_IO6	SS_CLKIN0P	16P	BK1_IO6	SS_CLKIN0P	14P

ispXPGA Logic Signal Connections: 256-Ball fpBGA (Cont.)

256-fpBGA Ball	LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ²	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ²
-	GND (Bank 1)	-	-	-	-	-
L3	BK1_IO7	SS_CLKIN0N	16N	BK1_IO7	SS_CLKIN0N	14N
K2	BK1_IO8	-	17P	BK1_IO8	-	15P
-	-	-	-	GND (Bank 1)	-	-
L2	BK1_IO9	-	17N	BK1_IO9	-	15N
M1	BK1_IO10	HSI1A_SOUTP	18P/HSI1	BK1_IO10	-	16P
N1	BK1_IO11	HSI1A_SOUTN	18N/HSI1	BK1_IO11	-	16N
M3	BK1_IO12	PLL_RST2	19P/HSI1	BK1_IO12	PLL_RST2	17P
M4	BK1_IO13	PLL_RST3	19N/HSI1	BK1_IO13	PLL_RST3	17N
-	GND (Bank 1)	-	-	-	-	-
M2	BK1_IO16 ¹	VREF1	-	BK1_IO14 ¹	VREF1	-
P1	BK1_IO18	HSI1B_SOUTP	22P/HSI1	BK1_IO16	-	19P
-	-	-	-	GND (Bank 1)	-	-
R1	BK1_IO19	HSI1B_SOUTN	22N/HSI1	BK1_IO17	-	19N
N3	BK1_IO20 ¹	-	-	BK1_IO18 ¹	-	-
N2	BK1_IO22	HSI1B_SINP	24P/HSI1	BK1_IO20	-	21P
-	GND (Bank 1)	-	-	-	-	-
P2	BK1_IO23	HSI1B_SINN	24N/HSI1	BK1_IO21	-	21N
P4	TCK	-	-	TCK	-	-
T2	TMS	-	-	TMS	-	-
T3	TOE	-	-	TOE	-	-
R3	BK2_IO0	-	26P	BK2_IO0	-	22P
R4	BK2_IO1	-	26N	BK2_IO1	-	22N
N5	BK2_IO2	-	27P	BK2_IO2	-	23P
-	GND (Bank 2)	-	-	-	-	-
P5	BK2_IO3	-	27N	BK2_IO3	-	23N
-	-	-	-	GND (Bank 2)	-	-
T4	BK2_IO6	-	29P	BK2_IO6	-	25P
T5	BK2_IO7	-	29N	BK2_IO7	-	25N
N6	BK2_IO8	-	30P	BK2_IO8	-	26P
P6	BK2_IO9	VREF2	30N	BK2_IO9	VREF2	26N
R5	BK2_IO10	-	31P	BK2_IO10	-	27P
-	GND (Bank 2)	-	-	-	-	-
R6	BK2_IO11	-	31N	BK2_IO11	-	27N
N7	BK2_IO12	-	32P	BK2_IO12	-	28P
-	-	-	-	GND (Bank 2)	-	-
P7	BK2_IO13	-	32N	BK2_IO13	-	28N
T6	BK2_IO14	-	33P	BK2_IO14	-	29P
T7	BK2_IO15	-	33N	BK2_IO15	-	29N
M8	BK2_IO16	-	34P	BK2_IO16	-	30P
M9	BK2_IO17	-	34N	BK2_IO17	-	30N
R7	BK2_IO18	-	35P	BK2_IO18	-	31P

ispXPGA Logic Signal Connections: 516-Ball fpBGA (Cont.)

516-Ball BGA Ball	LFX500			LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹
-	-	-	-	GND (Bank 0)	-	-	-	-	-
R2	GCLK0	-	LVDS Pair0P	GCLK0	-	LVDS Pair0P	GCLK0	-	LVDS Pair0P
R3	GCLK1	-	LVDS Pair0N	GCLK1	-	LVDS Pair0N	GCLK1	-	LVDS Pair0N
R4	VCCP0	-	-	VCCP0	-	-	VCCP0	-	-
T4	GNDP0	-	-	GNDP0	-	-	GNDP0	-	-
T3	GCLK2	-	LVDS Pair1P	GCLK2	-	LVDS Pair1P	GCLK2	-	LVDS Pair1P
T2	GCLK3	-	LVDS Pair1N	GCLK3	-	LVDS Pair1N	GCLK3	-	LVDS Pair1N
-	-	-	-	GND (Bank 1)	-	-	-	-	-
T1	BK1_IO0	CLK_OUT2	21P	BK1_IO0	CLK_OUT2	13P	BK1_IO0	CLK_OUT2	11P
-	GND (Bank 1)	-	-	-	-	-	-	-	-
U1	BK1_IO1	CLK_OUT3	21N	BK1_IO1	CLK_OUT3	13N	BK1_IO1	CLK_OUT3	11N
U2	BK1_IO2	SS_CLKOUT0P	22P	BK1_IO2	SS_CLKOUT0P	14P	BK1_IO2	SS_CLKOUT0P	12P
-	-	-	-	-	-	-	GND (Bank 1)	-	-
U3	BK1_IO3	SS_CLKOUT0N	22N	BK1_IO3	SS_CLKOUT0N	14N	BK1_IO3	SS_CLKOUT0N	12N
V1	BK1_IO4	PLL_FBK2	23P	BK1_IO4	PLL_FBK2	15P	BK1_IO4	PLL_FBK2	13P
V2	BK1_IO5	PLL_FBK3	23N	BK1_IO5	PLL_FBK3	15N	BK1_IO5	PLL_FBK3	13N
V3	BK1_IO6	-	24P	NC	-	-	NC	-	-
-	GND (Bank 1)	-	-	-	-	-	-	-	-
V4	BK1_IO7	-	24N	NC	-	-	NC	-	-
W1	BK1_IO8	-	25P	NC	-	-	NC	-	-
Y1	BK1_IO9	-	25N	NC	-	-	NC	-	-
W2	BK1_IO10	SS_CLKIN0P	26P	BK1_IO6	SS_CLKIN0P	16P	BK1_IO6	SS_CLKIN0P	14P
-	-	-	-	GND (Bank 1)	-	-	-	-	-
W3	BK1_IO11	SS_CLKIN0N	26N	BK1_IO7	SS_CLKIN0N	16N	BK1_IO7	SS_CLKIN0N	14N
Y2	BK1_IO12	-	27P	BK1_IO8	-	17P	BK1_IO8	-	15P
-	-	-	-	-	-	-	GND (Bank 1)	-	-
Y4	BK1_IO13	-	27N	BK1_IO9	-	17N	BK1_IO9	-	15N
Y3	BK1_IO14	-	28P	NC	-	-	NC	-	-
-	GND (Bank 1)	-	-	-	-	-	-	-	-
AA1	BK1_IO15	-	28N	NC	-	-	NC	-	-
AA2	BK1_IO16	-	29P	NC	-	-	NC	-	-
AA3	BK1_IO17	-	29N	NC	-	-	NC	-	-
AB2	BK1_IO18	HSI2A_SOUTP	30P	BK1_IO10	HSI1A_SOUTP	18P/HSI1	BK1_IO10	-	16P
AC2	BK1_IO19	HSI2A_SOUTN	30N	BK1_IO11	HSI1A_SOUTN	18N/HSI1	BK1_IO11	-	16N
AB3	BK1_IO20	PLL_RST2	31P	BK1_IO12	PLL_RST2	19P/HSI1	BK1_IO12	PLL_RST2	17P
AA4	BK1_IO21	PLL_RST3	31N	BK1_IO13	PLL_RST3	19N/HSI1	BK1_IO13	PLL_RST3	17N
AC1	BK1_IO22	HSI2A_SINP	32P	BK1_IO14	HSI1A_SINP	20P/HSI1	NC	-	-
-	GND (Bank 1)	-	-	GND (Bank 1)	-	-	-	-	-
AD1	BK1_IO23	HSI2A_SINN	32N	BK1_IO15	HSI1A_SINN	20N/HSI1	NC	-	-
AE1	BK1_IO24	VREF1	33P/HSI2	BK1_IO16	VREF1	21P/HSI1	BK1_IO14	VREF1	18P
AF1	BK1_IO25	-	33N/HSI2	BK1_IO17	-	21N/HSI1	BK1_IO15	-	18N
AC3	BK1_IO26	HSI2B_SOUTP	34P/HSI2	BK1_IO18	HSI1B_SOUTP	22P/HSI1	BK1_IO16	-	19P
-	-	-	-	-	-	-	GND (Bank 1)	-	-
AC4	BK1_IO27	HSI2B_SOUTN	34N/HSI2	BK1_IO19	HSI1B_SOUTN	22N/HSI1	BK1_IO17	-	19N
AD2	BK1_IO28	-	35P/HSI2	BK1_IO20	-	23P/HSI1	BK1_IO18	-	20P
AD3	BK1_IO29	-	35N/HSI2	BK1_IO21	-	23N/HSI1	BK1_IO19	-	20N
AE2	BK1_IO30	HSI2B_SINP	36P/HSI2	BK1_IO22	HSI1B_SINP	24P/HSI1	BK1_IO20	-	21P
-	GND (Bank 1)	-	-	GND (Bank 1)	-	-	-	-	-
AF2	BK1_IO31	HSI2B_SINN	36N/HSI2	BK1_IO23	HSI1B_SINN	24N/HSI1	BK1_IO21	-	21N
AD4	BK1_IO32	-	37P/HSI2	NC	-	-	NC	-	-

ispXPGA Logic Signal Connections: 516-Ball fpBGA (Cont.)

516-Ball BGA Ball	LFX500			LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹
AE3	BK1_IO33	-	37N/HSI2	NC	-	-	NC	-	-
AG1	BK1_IO34	-	38P/HSI2	NC	-	-	NC	-	-
AH1	BK1_IO35	-	38N/HSI2	NC	-	-	NC	-	-
AG2	BK1_IO36	-	39P/HSI2	NC	-	-	NC	-	-
AF3	BK1_IO37	-	39N/HSI2	NC	-	-	NC	-	-
AJ1	BK1_IO38	-	40P/HSI2	NC	-	-	NC	-	-
-	GND (Bank 1)	-	-	-	-	-	-	-	-
AH2	BK1_IO39	-	40N/HSI2	NC	-	-	NC	-	-
AG3	BK1_IO40	-	41P	BK1_IO24	-	25P/HSI1	NC	-	-
AF4	BK1_IO41	-	41N	BK1_IO25	-	25N/HSI1	NC	-	-
AK2	TCK	-	-	TCK	-	-	TCK	-	-
AJ3	TMS	-	-	TMS	-	-	TMS	-	-
AG5	TOE	-	-	TOE	-	-	TOE	-	-
AH4	BK2_IO0	-	42P	BK2_IO0	-	26P	BK2_IO0	-	22P
AK3	BK2_IO1	-	42N	BK2_IO1	-	26N	BK2_IO1	-	22N
AJ4	BK2_IO2	-	43P	BK2_IO2	-	27P	BK2_IO2	-	23P
-	GND (Bank 2)	-	-	GND (Bank 2)	-	-	-	-	-
AH5	BK2_IO3	-	43N	BK2_IO3	-	27N	BK2_IO3	-	23N
AK4	BK2_IO4	-	44P	BK2_IO4	-	28P	BK2_IO4	-	24P
-	-	-	-	-	-	-	GND (Bank 2)	-	-
AJ5	BK2_IO5	-	44N	BK2_IO5	-	28N	BK2_IO5	-	24N
AG7	BK2_IO6	-	45P	BK2_IO6	-	29P	BK2_IO6	-	25P
AH6	BK2_IO7	-	45N	BK2_IO7	-	29N	BK2_IO7	-	25N
AK5	BK2_IO8	-	46P	NC	-	-	NC	-	-
AJ6	BK2_IO9	-	46N	NC	-	-	NC	-	-
AG8	BK2_IO10	-	47P	NC	-	-	NC	-	-
-	GND (Bank 2)	-	-	-	-	-	-	-	-
AH7	BK2_IO11	-	47N	NC	-	-	NC	-	-
AK6	BK2_IO12	-	48P	NC	-	-	NC	-	-
AJ7	BK2_IO13	-	48N	NC	-	-	NC	-	-
AH8	BK2_IO14	-	49P	NC	-	-	NC	-	-
AG10	BK2_IO15	-	49N	NC	-	-	NC	-	-
AK7	BK2_IO16	-	50P	NC	-	-	NC	-	-
AJ8	BK2_IO17	-	50N	NC	-	-	NC	-	-
AH9	BK2_IO18	-	51P	NC	-	-	NC	-	-
-	GND (Bank 2)	-	-	-	-	-	-	-	-
AG11	BK2_IO19	-	51N	NC	-	-	NC	-	-
AK8	BK2_IO20	-	52P	BK2_IO8	-	30P	BK2_IO8	-	26P
AJ9	BK2_IO21	VREF2	52N	BK2_IO9	VREF2	30N	BK2_IO9	VREF2	26N
AH10	BK2_IO22	-	53P	BK2_IO10	-	31P	BK2_IO10	-	27P
-	-	-	-	GND (Bank 2)	-	-	-	-	-
AH11	BK2_IO23	-	53N	BK2_IO11	-	31N	BK2_IO11	-	27N
AJ10	BK2_IO24	-	54P	BK2_IO12	-	32P	BK2_IO12	-	28P
AK10	BK2_IO25	-	54N	BK2_IO13	-	32N	BK2_IO13	-	28N
AH12	BK2_IO26	-	55P	BK2_IO14	-	33P	BK2_IO14	-	29P
-	GND (Bank 2)	-	-	-	-	-	-	-	-
AJ11	BK2_IO27	-	55N	BK2_IO15	-	33N	BK2_IO15	-	29N
AK11	BK2_IO28	-	56P	NC	-	-	NC	-	-
AJ12	BK2_IO29	-	56N	NC	-	-	NC	-	-
AG13	BK2_IO30	-	57P	BK2_IO16	-	34P	BK2_IO16	-	30P
AH13	BK2_IO31	-	57N	BK2_IO17	-	34N	BK2_IO17	-	30N

ispXPGA Logic Signal Connections: 516-Ball fpBGA (Cont.)

516-Ball BGA Ball	LFX500			LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹
A10	BK7_IO18	-	156P	NC	-	-	NC	-	-
B10	BK7_IO19	-	156N	NC	-	-	NC	-	-
C10	BK7_IO20	VREF7	157P	BK7_IO16	VREF7	99P	BK7_IO12	VREF7	83P
D10	BK7_IO21	-	157N	BK7_IO17	-	99N	BK7_IO13	-	83N
B9	BK7_IO22	-	158P	BK7_IO18	-	100P	BK7_IO14	-	84P
-	GND (Bank 7)	-	-	-	-	-	-	-	-
C9	BK7_IO23	-	158N	BK7_IO19	-	100N	BK7_IO15	-	84N
A8	BK7_IO24	-	159P	BK7_IO20	-	101P	BK7_IO16	-	85P
-	-	-	-	-	-	-	GND (Bank 7)	-	-
B8	BK7_IO25	-	159N	BK7_IO21	-	101N	BK7_IO17	-	85N
C8	BK7_IO26	-	160P	NC	-	-	NC	-	-
D8	BK7_IO27	-	160N	NC	-	-	NC	-	-
A7	BK7_IO28	-	161P	NC	-	-	NC	-	-
B7	BK7_IO29	-	161N	NC	-	-	NC	-	-
C7	BK7_IO30	-	162P	NC	-	-	NC	-	-
-	GND (Bank 7)	-	-	-	-	-	-	-	-
D7	BK7_IO31	-	162N	NC	-	-	NC	-	-
A6	BK7_IO32	-	163P	NC	-	-	NC	-	-
B6	BK7_IO33	-	163N	NC	-	-	NC	-	-
B5	BK7_IO34	-	164P	NC	-	-	NC	-	-
C6	BK7_IO35	-	164N	NC	-	-	NC	-	-
A5	BK7_IO36	-	165P	NC	-	-	NC	-	-
A4	BK7_IO37	-	165N	NC	-	-	NC	-	-
B4	BK7_IO38	-	166P	BK7_IO22	-	102P	BK7_IO18	-	86P
-	GND (Bank 7)	-	-	GND (Bank 7)	-	-	-	-	-
C5	BK7_IO39	-	166N	BK7_IO23	-	102N	BK7_IO19	-	86N
A3	BK7_IO40	-	167P	BK7_IO24	-	103P	BK7_IO20	-	87P
A2	BK7_IO41	-	167N	BK7_IO25	-	103N	BK7_IO21	-	87N
D5	TDO	-	-	TDO	-	-	TDO	-	-
C4	VCCJ	-	-	VCCJ	-	-	VCCJ	-	-
B3	TDI	-	-	TDI	-	-	TDI	-	-

1. If a sysHSI Block is used, the indicated sysHSI reserved pins are unavailable for general purpose I/O use.

ispXPGA Logic Signal Connections: 680-Ball fpBGA

LFX1200			
680-Ball fpBGA	Signal Name	Second Function	LVDS Pair/sysHSI Reserved ¹
C4	BK0_IO0	-	0P
B4	BK0_IO1	-	0N
E6	BK0_IO2	-	1P
-	GND (Bank 0)	-	-
D6	BK0_IO3	-	1N
A4	BK0_IO4	-	2P
E8	BK0_IO5	-	2N
C5	BK0_IO6	HSI0A_SOUTP	3P
C6	BK0_IO7	HSI0A_SOUTN	3N
A6	BK0_IO8	-	4P
A5	BK0_IO9	-	4N
B6	BK0_IO10	HSI0A_SINP	5P/HSI0
-	GND (Bank 0)	-	-
B5	BK0_IO11	HSI0A_SINN	5N/HSI0
B7	BK0_IO12	VREF0	6P/HSI0
A7	BK0_IO13	-	6N/HSI0
D8	BK0_IO14	HSI0B_SOUTP	7P/HSI0
D7	BK0_IO15	HSI0B_SOUTN	7N/HSI0
D9	BK0_IO16	-	8P/HSI0
E10	BK0_IO17	-	8N/HSI0
C8	BK0_IO18	HSI0B_SINP	9P/HSI0
-	GND (Bank 0)	-	-
C7	BK0_IO19	HSI0B_SINN	9N/HSI0
A8	BK0_IO20	-	10P/HSI0
A9	BK0_IO21	-	10N/HSI0
C9	BK0_IO22	HSI1A_SOUTP	11P/HSI0
B8	BK0_IO23	HSI1A_SOUTN	11N/HSI0
B9	BK0_IO24	-	12P/HSI0
B10	BK0_IO25	-	12N/HSI0
D11	BK0_IO26	HSI1A_SINP	13P/HSI1
-	GND (Bank 0)	-	-
D10	BK0_IO27	HSI1A_SINN	13N/HSI1
A10	BK0_IO28	-	14P/HSI1
C12	BK0_IO29	-	14N/HSI1
D12	BK0_IO30	HSI1B_SOUTP	15P/HSI1
C11	BK0_IO31	HSI1B_SOUTN	15N/HSI1
A12	BK0_IO32	-	16P/HSI1
A13	BK0_IO33	-	16N/HSI1
B13	BK0_IO34	HSI1B_SINP	17P/HSI1
-	GND (Bank 0)	-	-
B12	BK0_IO35	HSI1B_SINN	17N/HSI1
E14	BK0_IO36	-	18P/HSI1

ispXPGA Logic Signal Connections: 680-Ball fpBGA (Cont.)

LFX1200			
680-Ball fpBGA	Signal Name	Second Function	LVDS Pair/sysHSI Reserved ¹
A33	BK1_IO45	-	53N/HSI4
C33	BK1_IO46	HSI4A_SINP	54P/HSI4
B33	BK1_IO47	HSI4A_SINN	54N/HSI4
A34	BK1_IO48	-	55P/HSI4
A35	BK1_IO49	VREF1	55N/HSI4
D32	BK1_IO50	HSI4B_SOUTP	56P/HSI4
-	GND (Bank 1)	-	-
D33	BK1_IO51	HSI4B_SOUTN	56N/HSI4
E32	BK1_IO52	-	57P
C34	BK1_IO53	-	57N
B34	BK1_IO54	HSI4B_SINP	58P
B35	BK1_IO55	HSI4B_SINN	58N
A36	BK1_IO56	-	59P
D34	BK1_IO57	-	59N
C35	BK1_IO58	-	60P
-	GND (Bank 1)	-	-
E34	BK1_IO59	-	60N
B36	BK1_IO60	-	61P
C36	BK1_IO61	-	61N
D39	TCK	-	-
D37	TMS	-	-
D38	TOE	-	-
E37	BK2_IO0	-	62P
F35	BK2_IO1	-	62N
E39	BK2_IO2	-	63P
-	GND (Bank 2)	-	-
F39	BK2_IO3	-	63N
F36	BK2_IO4	-	64P
E38	BK2_IO5	-	64N
G38	BK2_IO6	-	65P
F37	BK2_IO7	-	65N
G36	BK2_IO8	-	66P
G39	BK2_IO9	-	66N
H35	BK2_IO10	-	67P
-	GND (Bank 2)	-	-
F38	BK2_IO11	-	67N
J37	BK2_IO12	VREF2	68P
H36	BK2_IO13	-	68N
G37	BK2_IO14	-	69P
H37	BK2_IO15	-	69N
H39	BK2_IO16	-	70P
K35	BK2_IO17	-	70N
J36	BK2_IO18	-	71P

ispXPGA Logic Signal Connections: 680-Ball fpBGA (Cont.)

LFX1200			
680-Ball fpBGA	Signal Name	Second Function	LVDS Pair/sysHSI Reserved ¹
AK2	BK6_IO23	-	197N
AK1	BK6_IO24	-	198P
AJ4	BK6_IO25	-	198N
AJ3	BK6_IO26	-	199P
-	GND (Bank 6)	-	-
AH4	BK6_IO27	-	199N
AH3	BK6_IO28	-	200P
AH2	BK6_IO29	-	200N
AH1	BK6_IO30	-	201P
AG4	BK6_IO31	-	201N
AF5	BK6_IO32	DATA7	202P
AG3	BK6_IO33	DATA6	202N
AG2	BK6_IO34	-	203P
-	GND (Bank 6)	-	-
AF4	BK6_IO35	-	203N
AF3	BK6_IO36	DATA5	204P
AG1	BK6_IO37	DATA4	204N
AE2	BK6_IO38	-	205P
AF1	BK6_IO39	-	205N
AF2	BK6_IO40	-	206P
AE1	BK6_IO41	-	206N
AE4	BK6_IO42	-	207P
-	GND (Bank 6)	-	-
AD4	BK6_IO43	-	207N
AD5	BK6_IO44	-	208P
AD3	BK6_IO45	-	208N
AD2	BK6_IO46	-	209P
AD1	BK6_IO47	-	209N
AC4	BK6_IO48	-	210P
AC3	BK6_IO49	-	210N
AC2	BK6_IO50	DATA3	211P
-	GND (Bank 6)	-	-
AC1	BK6_IO51	DATA2	211N
AB3	BK6_IO52	-	212P
AB4	BK6_IO53	-	212N
AB2	BK6_IO54	DATA1	213P
AB1	BK6_IO55	DATA0	213N
AA3	BK6_IO56	-	214P
AA4	BK6_IO57	-	214N
AA5	BK6_IO58	-	215P
-	GND (Bank 6)	-	-
AA2	BK6_IO59	-	215N
AA1	BK6_IO60	-	216P

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved ¹
AK5	BK2_IO7	-	65N	BK2_IO7	-	45N
AE7	BK2_IO8	-	66P	BK2_IO8	-	46P
AF7	BK2_IO9	-	66N	BK2_IO9	-	46N
AG7	BK2_IO10	-	67P	BK2_IO10	-	47P
-	GND (Bank 2)	-	-	GND (Bank 2)	-	-
AH7	BK2_IO11	-	67N	BK2_IO11	-	47N
AE8	BK2_IO12	VREF2	68P	BK2_IO21	VREF2	52N
AF8	BK2_IO13	-	68N	BK2_IO20	-	52P
AJ6	BK2_IO14	-	69P	BK2_IO12	-	48P
AK6	BK2_IO15	-	69N	BK2_IO13	-	48N
AG8	BK2_IO16	-	70P	BK2_IO14	-	49P
AH8	BK2_IO17	-	70N	BK2_IO15	-	49N
AJ7	BK2_IO18	-	71P	BK2_IO16	-	50P
-	GND (Bank 2)	-	-	-	-	-
AK7	BK2_IO19	-	71N	BK2_IO17	-	50N
AF9	BK2_IO20	-	72P	BK2_IO18	-	51P
-	-	-	-	GND (Bank 2)	-	-
AG9	BK2_IO21	-	72N	BK2_IO19	-	51N
AJ8	BK2_IO22	-	73P	NC	-	-
AK8	BK2_IO23	-	73N	NC	-	-
AD10	BK2_IO24	-	74P	NC	-	-
AE10	BK2_IO25	-	74N	NC	-	-
AJ9	BK2_IO26	-	75P	NC	-	-
-	GND (Bank 2)	-	-	-	-	-
AK9	BK2_IO27	-	75N	NC	-	-
AF10	BK2_IO28	-	76P	NC	-	-
AG10	BK2_IO29	-	76N	NC	-	-
AK10	BK2_IO30	-	77P	NC	-	-
AJ10	BK2_IO31	-	77N	NC	-	-
AE11	BK2_IO32	-	78P	NC	-	-
AF11	BK2_IO33	-	78N	NC	-	-
AG11	BK2_IO34	-	79P	NC	-	-
-	GND (Bank 2)	-	-	-	-	-
AH11	BK2_IO35	-	79N	NC	-	-
AE12	BK2_IO36	-	80P	NC	-	-
AF12	BK2_IO37	-	80N	NC	-	-
AJ11	BK2_IO38	-	81P	NC	-	-
AK11	BK2_IO39	-	81N	NC	-	-
AG12	BK2_IO40	-	82P	NC	-	-
AH12	BK2_IO41	-	82N	NC	-	-
AK12	BK2_IO42	-	83P	BK2_IO22	-	53P
-	GND (Bank 2)	-	-	-	-	-

Revision History (Cont.)

Date	Version	Change Summary
June 2004 (cont.)	08.0 (cont.)	Updated Global Clock Input Setup time specifications.
		Clarification of Serial Out LVDS test condition.
		Clarification of REFCLK, SS_CLKIN peak-to-peak period jitter condition.
		Added sysHSI Reserved pins and footnote.
		Removed industrial ordering part numbers.
July 2004	09.0	Added "E" Series product family.
August 2004	10.0	Final release.
December 2004	10.1	Updated NC Connections table.
April 2005	10.2	Clarification of IDK specification.
April 2005	11.0	Select lead-free packages release.
July 2005	12.0	Added lead-free 516 fpBGA ordering part numbers.
April 2007	13.0	Removed lead-free 680 fpSBGA information from Part Number Description and Ordering Part Number tables. Removed lead-free 516 fpBGA for LFX125 from Ordering Part Number tables.
November 2007	14.0	Removed lead-free 516 fpBGA information from Part Number Description and Ordering Part Number tables.
July 2008	14.1	Added 516 fpBGA package without heat spreader to Part Number Description and Ordering Part Number tables.
February 2010	15.0	Ordering part numbers and ispXPGA Family Selection Guide table have been updated per PCN #03A-10 (discontinuation of the ispXPGA 1200 devices).
		References to "system gates" changed to "functional gates."